

# IEEE 802.11ah Sub-1 GHz Wi-Fi HaLow Module

## User Guide

Product Name	MRF61_F1
Model Name	MFIM0002
T/N	MBWM000002 MBWM000024

Version 1.1  
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MegaChips Corporation

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(If the customer intends to use the devices for applications other than those specified between the customer and MCC, please contact MCC sales representative before such use.)

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## 5. Radiation-proof design

This device has not been designed to be radiation-resistant.

## 6. Export restriction

The export of this device may be regulated by the government under customs, anti-proliferation rules, or other regulations, and export may be prohibited without governmental license.

## 7. No prior notice of revision

These specifications are based on materials dated [02/10/2025](#), and MCC reserves the right to revise these specifications without any prior notice. For mass production planning, please reference the latest version of the specifications.

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# 1. Product Overview

## 1.1 Introduction

MegaChips provides a complete Wi-Fi HaLow connectivity solution. The MFIM0002 is a fully integrated Wi-Fi HaLow® modules with long-range, low-power consumption and superior RF performance, featuring the MM6108 Wi-Fi HaLow SoC.

The MFIM0002 are designed in compliance with the IEEE 802.11ah standard, supporting data rates up to 32.5 Mbps with programmable operation between 902 MHz and 928 MHz.

MRF61\_F1\_FL(T/N : MBWM000002) has U.FL connector and output to U.FL connector.

MRF61\_F1\_TH(T/N : MBWM000024) does not have U.FL connector and output to Plated Half-hole.

Primary Function of ANT pin (pin number 44) is different.

Please see "3.3 Pin Diagram".

This module includes ultra-long-reach PA, high linearity LNA, T/R switch, 32 MHz crystal oscillator and it has been designed for a simplified Wi-Fi HaLow connection to an external host for applications in which a customer wants to merely replace their prior RF technology with a Wi-Fi HaLow connection while leveraging the latest WPA3 security protocol.

Battery-operated applications are supported by a combination of features which are inherently supported by the module. The IEEE 802.11ah standard provides for extended sleep times for battery-operated Stations (STAs or client devices), with longer durations than other prior IEEE 802.11a/b/g/n/ac generations. It also allows longer extended maximum idle times for clients to conserve energy without being removed from the access point's (AP's) list of associated devices.

## 1.2 Features

Table 1-1 Features

Ultra-long-range, low-power Wi-Fi HaLow module for IoT Applications:	
Frequency Band	920MHz Band(Sub-1GHz Band)
Channel Band Width	1MHz/2MHz/4MHz/8MHz
Maximum Transmission power	20dBm
Modulation method	OFDM
Sub carrier modulation method (It is depended on communication conditions)	BPSK,QPSK,16-QAM,64-QAM
Theoretical maximum transmission rate	32.5Mbps(In case of 8MHz BW,MCS7)

## 1.3 Applications

For Internet of Things (IoT) and Machine-to-Machine (M2M) applications such as:

- Surveillance Cameras and Sensors
- Cloud Connectivity
- Low-power Sensor Networks
- Building Automation Systems (BAS)
- Asset Tracking and Management
- Machine Performance Monitors & Sensors
- Building Access Control & Security
- Drone Video and Navigation Communications
- Connected Toys and Games
- Rural Internet Access
- Agricultural and Farm Networks
- Utility Smart Meter and Intelligent Grid
- Proximity Sensors
- Industrial Automation Controls
- Smart Home Automation
- EV Car Chargers
- Appliances
- Construction Site Connectivity
- Smart Signs and Kiosks
- Retail Point-of-Sale Terminals
- IP Sensor Networks
- Biometric IDs and Keypads
- Warehouse Connectivity
- Intelligent Lighting Controls
- BT/ZigBee<sup>TM</sup>/Z-Wave<sup>TM</sup> to Wi-Fi HaLow Gateways
- Wi-Fi to Wi-Fi HaLow Bridges
- Wi-Fi HaLow Client Adapters/Dongles
- Smart City Networks

## 2. Product Specifications

### 2.1 Product specifications

Table 2-1 Product Specifications

Product Specifications	
Power supply	Voltage
	VBAT : +3.0~+3.6V VDD_FEM : +3.0~+3.6V VDDIO : +1.8~+3.6V
Maximum power consumption	T.B.D
Maximum Storage temperature	-40°C~+125°C
Maximum Storage temperature	-40°C~+85°C
RF performance	RF terminal Impedance Frequency range
	50ohms 902MHz~928MHz
External Dimensions	23mm x 14mm x 2.58mm
Weight	2g

### 2.2 Channel Frequency

Table 2-2 TX/RX Frequency

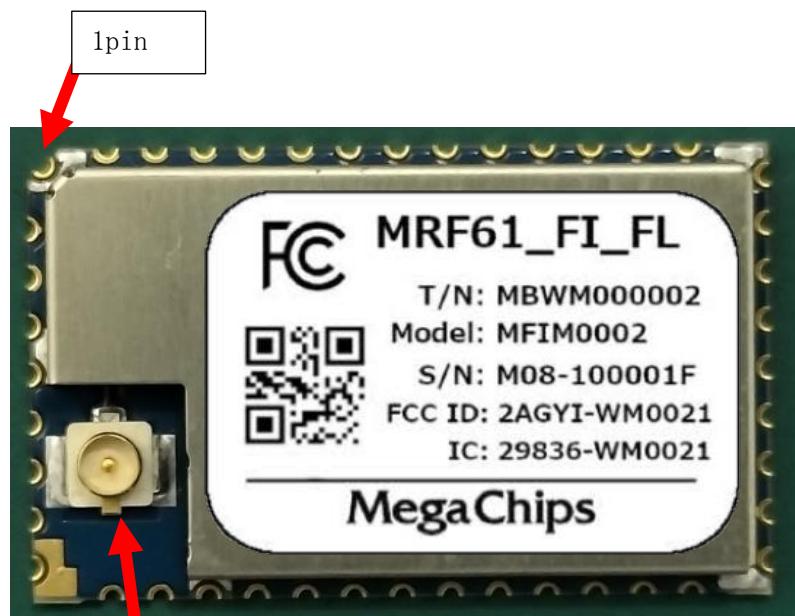
Channel spacing (MHz)	Channel center frequency index	Channel center frequency (MHz)	Channel center frequency index	Channel center frequency (MHz)
1	3	903.5	29	916.5
	5	904.5	31	917.5
	7	905.5	33	918.5
	9	906.5	35	919.5
	11	907.5	37	920.5
	13	908.5	39	921.5
	15	909.5	41	922.5
	17	910.5	43	923.5
	19	911.5	45	924.5
	21	912.5	47	925.5
	23	913.5	49	926.5
	25	914.5		
	27	915.5		

2	6	905.0	34	919.0
	10	907.0	38	921.0
	14	909.0	42	923.0
	18	911.0	46	925.0
	22	913.0		
	26	915.0		
	30	917.0		
4	8	906.0	32	918.0
	16	910.0	40	922.0
	24	914.0	48	926.0
8	12	908.0		
	28	916.0		
	44	924.0		

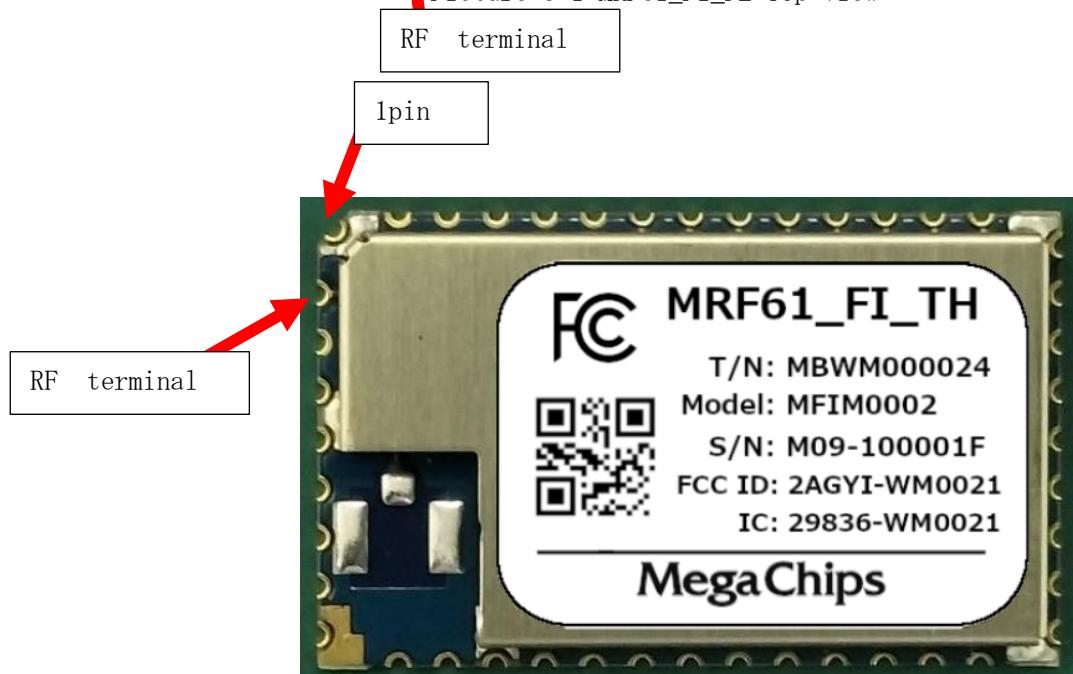
### 3. Functional Description

The following sections describe the functions of the MFIM0002 device.

#### 3.1 Exterior View



Picture 3-1 MRF61\_FI\_FL Top view



Picture 3-2 MRF61\_FI\_TH Top view



Picture 3-3 MRF61\_F1/TH Bottom view

## 3.2 Pin Diagram

Table 3-1 Pin Diagram

Pin	Name	Type	Primary Function	remarks
1	GND	Power	Ground	
2	GND	Power	Ground	
3	GND	Power	Ground	
4	GND	Power	Ground	
5	GND	Power	Ground	
6	GND	Power	Ground	
7	Reserved	I		implement a 10kΩ pull-down resistor
8	Reserved	I		implement a 10kΩ pull-down resistor
9	NC	NC	Do Not Connect	
10	Reserved	I		implement a 10kΩ pull-down resistor
11	Reserved	I		
12	Reserved	O		implement a 10kΩ pull-down resistor
13	NC	NC	Do Not Connect	
14	NC	NC	Do Now Connect	implement a 10kΩ pull-down resistor
15	GND	Power	Ground	
16	Reserved	I/O		implement a 10kΩ pull-down resistor
17	Reserved	I/O		implement a 10kΩ pull-down resistor
18	Reserved	I/O		implement a 10kΩ pull-down resistor
19	SD_D1(*1)	I/O	SDIO D1 / SPI_INT	
20	SD_D0(*1)	I/O	SDIO D0 / SPI_MISO	
21	SD_CLK	I/O	SDIO Clock / SPI_SCK	
22	VDDIO	Power	3.3V Power (MM6108 I/O)	
23	GND	Power	Ground	
24	SD_CMD(*1)	I/O	SDIO Command / SPI_MOSI	
25	SD_D3(*1)	I/O	SDIO D3 / SPI_CS	
26	SD_D2(*1)	I/O	SDIO D2	
27	Reserved	I/O		implement a 10kΩ pull-down resistor
28	VBAT	Power	3.3V Power (MM6108)	
29	GND	Power	Ground	
30	Reserved	I/O		implement a 10kΩ pull-down resistor

31	Reserved	I/O		implement a 10kΩ pull-down resistor
32	Reserved	I/O		implement a 10kΩ pull-down resistor
33	VDD_FEM	Power	3.3V Power (for PA)	
34	GND	Power	Ground	
35	Reserved	I/O		implement a 10kΩ pull-down resistor
36	Reserved	I/O		implement a 10kΩ pull-down resistor
37	GND	Power	Ground	
38	BUSY	O	BUSY output	implement a 10kΩ pull-down resistor
39	RESET_N	I	RESET input	
40	WAKE	I	WAKE input	
41	GND	Power	Ground	
42	GND	Power	Ground	
43	GND	Power	Ground	
44	ANT	Analog	RF in/out pin. Connects to antenna. MRF61_F1_FL : N.C MRF61_F1_TH: ANT	

## 4. Certification

### 4.1 FCC

The host manufacturer should reference KDB Publication 996369 D04 Module Integration Guide.

#### **Federal Communication Commission Interference Statement**

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the use is encouraged to try to correct the interference by one of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

FCC Caution: Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate this equipment.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference.
- (2) this device must accept any interference received, including interference that may cause undesired operation.

#### **IMPORTANT NOTE:**

##### FCC Radiation Exposure Statement:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with a minimum distance 20cm between the radiator and your body.

#### **IMPORTANT NOTE:**

This module is intended for OEM integrators. This module is only FCC authorized for the specific rule parts listed on the grant, and that the host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification. The final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed.

Additional testing and certification may be necessary when multiple modules are used.

**USERS MANUAL OF THE END PRODUCT:**

In the user's manual of the end product, the end user must be informed to keep at least 20cm of separation with the antenna while this end product is installed and operated. The end user must be informed that the FCC radio-frequency exposure guidelines for an uncontrolled environment can be satisfied.

The end user must also be informed that any changes or modifications not expressly approved by the manufacturer could void the user's authority to operate this equipment.

This device complies with Part 15 of FCC rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference and (2) this device must accept any interference received, including interference that may cause undesired operation.

**LABEL OF THE END PRODUCT:**

The final end product must be labeled in a visible area.

This device complies with Part 15 of FCC rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference and (2) this device must accept any interference received, including interference that may cause undesired operation.

This module has been tested and found to comply with the following requirements for Modular Approval.

- Part 15.247 - Operation within the bands 902-928 MHz, 2400-2483.5 MHz, and 5725-5850 MHz.

### RF exposure considerations

In the end product, the antenna(s) used with this transmitter must be installed to provide a separation distance of at least 20cm from all persons and must not be co-located or operation in conjunction with any other antenna or transmitter except in accordance with multi-transmitter product procedures. User and installers must be provided with antenna installation instructions and transmitter operating conditions for satisfying the RF exposure compliance.

### Antennas

This radio transmitter has been approved by the FCC and ISED to operate with the antenna types listed below with the maximum permissible gain indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

### Antennes

Cet émetteur radio a été approuvé par la FCC et ISED pour fonctionner avec les types d'antennes répertoriés ci-dessous avec le gain maximal autorisé indiqué. Les types d'antennes non inclus dans cette liste, ayant un gain supérieur au gain maximum indiqué pour ce type, sont strictement interdits pour une utilisation avec cet appareil.

Antenna Type	Supplier	Antenna Part No.	Freq. (MHz)	Peak Antenna Gain (dBi)
Chip	KYOCERA AVX	P822603	902-928	0.7
	Johanson Technology	0915AT43A0026001E		-1.0
Dipole	Pulse Electronics	W1063	902-928	1.0
Monopole	TE Connectivity Linx	ANT-916-CW-RCS		4.8
	molex	1052620002		1.5
	molex	2111400100		1.0
	molex	1052620001		1.6

### Required End Product Labeling

Any device incorporating this module must display an external, visible, permanently affixed label with the FCC ID and the ISED certification number preceded by the term as follows.

“ Contains FCC ID: 2AGYI-WM0021”

“ Contains IC: 29836-WM0021”

### Obligation d'étiquetage du produit final:

Tout appareil intégrant ce module doit afficher une étiquette externe, visible et apposée en permanence avec le numéro de certification ISDE précédé du terme comme suit.

#### « Contient IC : 29836-WM0021 »

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module. The end user manual shall include all required regulatory information/warning as shown in User manual.

#### Test Modes

This device uses various test mode programs for test set up which operate separate from production firmware. Host integrators should contact the grantee for assistance with test modes needed for module/host compliance test requirements.

Contact information:

Company Name: MegaChips Corporation

Address: 1-1-1, Miyahara, Yodogawa-ku, Osaka, Japan 532-0003

Contact Email: [nishigami.kazuaki@megachips.co.jp](mailto:nishigami.kazuaki@megachips.co.jp)

Contact Phone: +81663992884

#### Additional testing, Part 15 Subpart B disclaimer

The modular transmitter is only FCC authorized for the specific rule parts (i.e., FCC transmitter rules) listed on the grant, and that the host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification.

The final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed.

#### Note EMI Considerations

Note that a host manufacturer is recommended to use KDB996369 D04 Module Integration Guide recommending as "best practice" RF design engineering testing and evaluation in case non-linear interactions generate additional non-compliant limits due to module placement to host components or properties.

For standalone mode, reference the guidance in KDB996369 D04 Module Integration Guide and for simultaneous mode; see KDB996369 D02 Module Q&A Question 12, which permits the host manufacturer to confirm compliance.

#### How to make changes

Only Grantees are permitted to make permissive changes, if the module will be used differently than granted conditions, please contact us to ensure modifications will not affect compliance.

Contact information:

Company Name: MegaChips Corporation

Address: 1-1-1,Miyahara, Yodogawa-ku, Osaka, Japan 532-0003

Contact Email: [nishigami.kazuaki@megachips.co.jp](mailto:nishigami.kazuaki@megachips.co.jp)

Contact Phone: +81663992884

## 4.2 ISED

This device contains license-exempt transmitter(s)/receiver(s) that comply with Innovation, Science and Economic Development Canada's licence-exempt RSS(s). Operation is subject to the following two conditions:

- (1) This device may not cause interference.
- (2) This device must accept any interference, including interference that may cause undesired operation of the device.

Cet appareil contient des émetteurs / récepteurs exempts de licence qui sont conformes au (x) RSS (s) exemptés de licence d'Innovation, Sciences et Développement économique Canada. L'opération est soumise aux deux conditions suivantes:

- (1) Cet appareil ne doit pas provoquer d'interférences.
- (2) Cet appareil doit accepter toute interférence, y compris les interférences susceptibles de provoquer un fonctionnement indésirable de l'appareil.

This device and its antenna(s) must not be co-located with any other transmitters except in accordance with IC multi-transmitter product procedures.

Referring to the multi-transmitter policy, multiple-transmitter(s) and module(s) can be operated simultaneously without reassessment permissive change.

Cet appareil et son antenne (s) ne doit pas être co-localisés ou fonctionnement en association avec une autre antenne ou transmetteur.

This radio transmitter has been approved by Innovation, Science and Economic Development Canada to operate with the antenna types listed below, with the maximum permissible gain indicated. Antenna types not included in this list that have a gain greater than the maximum gain indicated for any type listed are strictly prohibited for use with this device.

Le présent émetteur radio a été approuvé par Innovation, Sciences et Développement économique Canada pour fonctionner avec les types d'antenne énumérés ci-dessous et ayant un gain admissible maximal d'antenne. Les types d'antennes non inclus dans cette liste qui ont un gain supérieur au gain maximal indiqué pour tout type listé sont strictement interdits pour une utilisation avec cet appareil.

**IMPORTANT NOTE:****IC Radiation Exposure Statement:**

This equipment complies with IC RSS-102 radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

Cet équipement est conforme aux limites d'exposition aux rayonnements IC établies pour un environnement non contrôlé. Cet équipement doit être installé et utilisé avec un minimum de 20 cm de distance entre la source de rayonnement et votre corps.

Any changes or modifications not expressly approved by the manufacturer could void the user's authority to operate this equipment.

**USERS MANUAL OF THE END PRODUCT:**

In the user's manual of the end product, the end user must be informed to keep at least 20cm separation with the antenna while this end product is installed and operated. The end user must be informed that the IC radio-frequency exposure guidelines for an uncontrolled environment can be satisfied.

The end user must also be informed that any changes or modifications not expressly approved by the manufacturer could void the user's authority to operate this equipment. Operation is subject to the following two conditions: (1) this device may not cause harmful interference (2) this device must accept any interference received, including interference that may cause undesired operation.

**LABEL OF THE END PRODUCT:**

The final end product must be labeled in a visible area.

The Host Model Number (HMN) must be indicated at any location on the exterior of the end product or product packaging or product literature which shall be available with the end product or online.

## 5. Handling and Storage

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The MM610x-MF08251 class of modules are a moisture sensitive device rated at Moisture Sensitive Level 3 (MSL3) per IPC/JEDEC J-STD-20.

After opening the moisture sealed storage bag, modules that will be subjected to reflow solder or other high temperature processes must be:

1. Mounted to a circuit board within 168 hours at factory conditions ( $\leq 30^{\circ}\text{C}$  and  $< 60\%$  RH)

OR

2. Continuously stored per IPC/JEDEC J-STD-033

Modules that have been exposed to moisture and environmental conditions exceeding packaging and storage conditions MUST be baked before mounting according to IPC/JEDEC J-STD-033. Failure to meet packaging and storage conditions will result in irreparable damage to modules during solder reflow.

## 6. Revision History

Date:	22/07/2024	Version:	1.0	Detail:	
Date:	14/01/2025	Version:	1.1	Detail:	Revised Product Name, Model Name and T/N. Removed W1063M and ANT-916-CW-RCS-SMA from antenna list.

**MegaChips**